# imall

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## Contact us

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#### Composite Transistors

# XN0F263

### Silicon NPN epitaxial planar type

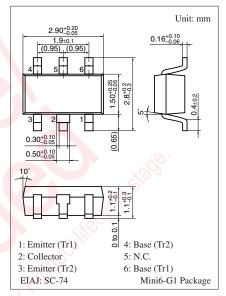
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#### Features

- Two elements incorporated into one package (collector-coupled transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half
- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	20	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	15	V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V
Collector current	I <sub>C</sub>	600	mA
Total power dissipation	P <sub>T</sub>	300	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C



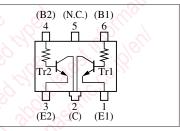
#### Marking Symbol: 2H

#### Internal Connection

200

270

200



Max

1

1

600

50

325

Unit

V

v

v

μΑ

μΑ

mV

Ω

MHz

#### Parameter Symbol Conditions Min Тур Collector-base voltage (Emitter open) V<sub>CBO</sub> $I_{\rm C} = 1 \ \mu A, I_{\rm E} = 0$ 20 $I_{C} = 1 \text{ mA}, I_{B} = 0$ Collector-emitter voltage (Base open) V<sub>CEO</sub> 15 5 $I_E = 1 \ \mu A, I_C = 0$ Emitter-base voltage (Collector open) VEBO Collector-base cutoff current (Emitter open) $V_{CB} = 20 \text{ V}, I_E = 0$ $I_{CBO}$ $V_{EB} = 5 V, I_C = 0$ Emitter-base cutoff current (Collector open) $I_{EBO}$ $V_{CE} = 5 \text{ V}, I_{C} = 50 \text{ mA}$ Forward current transfer ratio h<sub>FE</sub> 100

V<sub>CE(sat)</sub>

 $R_1$ 

 $\mathbf{f}_{\mathrm{T}}$ 

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

 $I_{C} = 50 \text{ mA}, I_{B} = 2.5 \text{ mA}$ 

 $V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$ 

Collector-emitter saturation voltage

Input resistance

Transition frequency

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